STEERING THE FUTURE OF INNOVATION
Automotive Semiconductor Solutions for a safe and secure driving experience
Engineers in the world face significant challenges when working on innovations to shape a better future.

Innovations need ideas.
Renesas is at the core of the technological innovation. Customers trust in our quality, reliability and market leadership. Our leading-edge embedded solutions allow customers to focus their resources on innovation. When it comes to realizing ideas, we want the engineers to remember Renesas first. Because Renesas is the enabler of Big Ideas.
THE WORLD LEADING EMBEDDED SOLUTION PROVIDER

WHO WE ARE

Renesas is a global semiconductor company delivering trusted embedded design innovation with complete semiconductor solutions that enable billions of connected, intelligent devices to enhance the way people work and live—securely and safely. A global leader in microcontrollers, analog, power, SoC products and integrated platforms, Renesas provides expertise, quality, and comprehensive solutions for a broad range of Automotive, Industrial, Home Electronics, Office Automation and Information Communication Technology applications to help shape a limitless future.

- Global leader in Microcontrollers, Analog, Power and SoC products
- Supports a broad range of Automotive, Industrial, Home Electronics, Office Automation, and Information Communication Technology applications
- 715.7 billion yen revenue in 2020
- 21,000 employees worldwide
- Headquartered in Tokyo, Japan with a strong global footprint

OUR HISTORY

Renesas is built on a strong historical foundation of technological innovation originating from Hitachi, Mitsubishi and NEC. Fueled by integrations with Intersil, IDT, Dialog, and Celeno, Renesas is now poised to extend its share in fast-growing data economy markets such as infrastructure and data center, and strengthen its presence in the industrial and automotive segments.

- NEC Electronics Spin-off from NEC
- Renesas Electronics started operation NEC Electronics and Renesas Technology merged
- Acquisition of Intersil Expanded lineup of analog products
- Acquisition of Dialog and Celeno Expanded lineup of analog products
- Renesas Technology Spin-off from Hitachi and Mitsubishi merger
- Investment by INCJ
- Acquisition of IDT Expanded lineup of analog products

The Renesas Automotive Solutions Business Unit addresses the specific requirements of the automotive industry. Thanks to the combination of leading-edge technologies and the company’s deep understanding of customer’s requirements, Renesas offers a wide range of innovative solutions. Embracing customer needs, i.e. zero accidents, zero stress, and zero emissions, we design our solutions to make cars safer, more comfortable and environmentally friendly.

With Renesas’ scalable MCU and SoC platforms, supplemented by efficient power and MSIG product and ever-growing software offers, we deliver all ingredients to cover groundbreaking applications shaping the future of mobility. Being at the edge of technological innovation Renesas offers it’s solutions to support the mega trends that drive the industry: Connected, Automated, Shared, and Electrified with enabling E/E architecture changes.

**Automotive Competence**

Renesas

- **... is a leading MCU/SoC supplier**
  
  W/W shipments reached over 1,4b units in 2020

- **... offers advanced process technologies**
  
  16nm FinFET for SoC and 28nm for MCU

- **... is best in quality**
  
  Extremely low failure rate at 0.1ppm

- **... is dedicated to support** on both local and global levels

- **... is a committed long-term partner**

- **... is the preferred supplier** to almost all system suppliers and car manufacturers

- **... provides of an Open Solution Platform** accelerating time to market
  
  With our partners we offer a robust ecosystem increasing development efficiency
CONNECTED CAR
With Renesas’ solutions cars are connected safe & secure from vehicle to cloud.

ADAS/AUTOMATED DRIVE
Renesas offers solutions for sensing, analyzing and controlling for a safe, secure and comfortable driving experience.

xEV
Renesas’ robust, reliable and safe powertrain solutions help to manage efficient use of energy.

GATEWAY/CAR SERVER
With its rich product portfolio, Renesas supports automakers’ vision of driving toward the mobility society of the future. We are committed to supporting a system chipset solution for Connected Gateway/Car server applications beyond just providing silicon.

**Product Portfolio**

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<tr>
<th><strong>Microcontrollers</strong></th>
<th><strong>Analog &amp; Power Products</strong></th>
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<tbody>
<tr>
<td><img src="image" alt="RL78" /></td>
<td>Bluetooth Low Energy (BLE)</td>
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<tr>
<td><img src="image" alt="RH850" /></td>
<td>Haptics Driver</td>
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<tr>
<td>16-bit ultra low power MCU</td>
<td>LED Driver</td>
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<tr>
<td>Sensing and motor control</td>
<td>Clocks and Timing Solutions</td>
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<tr>
<td>32-bit high-performance MCU</td>
<td>Sensor Solutions</td>
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<tr>
<td>Rich functional safety and security features</td>
<td>Power Management IC (PMIC)</td>
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<td>Battery Management IC (BMIC)</td>
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<td>Video Signal Processing (VSP)</td>
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<td>Wireless Power Charging IC</td>
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<td>Automotive HD Link (AHL)</td>
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<td>Gate Driver Unit (GDU)</td>
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<td>PowerMOSFETs</td>
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<td>Intelligent Power Devices (IPD)</td>
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To showcase how our complementary products work together to deliver comprehensive solutions, we’ve developed many “Winning Combinations”, compelling Renesas-plus-Intersil-plus-IDT-plus-Dialog product combinations that capture and highlight the technological advantages Renesas and the 3 acquired companies can provide as a combined company. Our complementary product portfolios of Analog + Power + Embedded Processing work together to deliver comprehensive solutions that help our customers accelerate their designs and get to market faster.

To learn more about our Winning Combinations, visit https://www.renesas.com/eu/en/solutions/automotive.html

### Automotive Battery Management System

- **System Benefits**
  - Best BMS accuracy and long-term drift (LTD), which extend driving range and battery life performance, with superior accuracy of \(<\pm2.5\text{mV}\) and \(<\pm6\text{mV}\) LTD
  - Lowest BOM cost and best FuSa/EMC/hot-plug solution, which alleviates R&D effort and is easy to use with Renesas’ RH850 MCU Family (with dedicated drivers and software for BMS)
  - MCU line-up supporting functional safety features up to ASIL D as well as required security
  - Intelligent power device (IPD) for external load control
  - Full system deliverables committed to automotive quality and support, which is optimized to be used high voltage Battery Management applications

- **Recommended Devices**
  - RH850/P1M
  - ISL78714
  - RV1S27520**
  - uPD166031A-34**
  - RAJ2800024/34/44**
  - RAA270005

*1 Not contained in the reference board, please verify on customer board

- **Optional Devices**
  - RAA270005
  - Power Management IC (PMIC)

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**Block Diagram**

- 12V Battery
- PMIC RAA270005
- IPD
- Fan
- Pump
- Relay
- CAN
- LIN
- ETH
- Car Network
- MCU RH850/P1M
- T-Sense
- I-Sense
- Outside
- Optional
- BCM ISL78714
- BCM ISL78714
- Photocoupler RV1S27520
- Tx/Rx

**Reference Board**
**BLDC Motor Control Using Inductive Position Sensor**

- System Benefits
  - High precision motor control based on inductive position sensing technology.
  - Effective torque control under all load conditions. Low noise and vibration. High precision during brake&hold functions.
  - Cost effective – no additional magnet or sensor cost. Shielding is not required.
  - Wide array of MCU line-up supporting functional safety features (FuSa) as well as security features (various ICU classes supported via integrated HW) and AUTOSAR (MCAL).

- Block Diagram

**Low-Cost Digital Instrument Cluster Reference Design**

- System Benefits
  - Low Cost Digital Instrument Cluster reference design using MCU + VSP scaler
  - Less software work to support multiple display resolutions with a single design
  - Generate cluster graphics in one resolution with the RH850 MCU, then easily scale to different resolutions using the RAA278840 LCD controller
  - Uses the RAA278840 LCD controller to upscale the graphics to 1920x720 to support an upgrade option to a 12.3-inch panel for premium trim vehicle models
  - Utilizes the RAA278840 LCD controller for “fast boot” to display tell-tale lamps at ignition (<500ms to display OSD through the RAA278840), allowing the MCU software time to boot up properly
  - Optimized power management ICs for the camera and ECU

- Block Diagram

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**Recommended Devices**

- RH850/D1M1A  32bit Microcontroller with 2D GPU
- RAA278840  LCD Controller
- ISL78206  Primary Regulators
- ISL78171  LED Backlight Controller
- ISL78419  TFT PMIC

**Optional Devices**

- ISL78206  Primary Regulator
- ISL76863  Light-to-Digital Output Sensor

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**Reference Board**
Renesas provides cutting edge chip solutions for the quickly evolving and complex ADAS and Autonomous driving market. Our goal is to enable customers with high compute chips that are designed with focus on Functional Safety and Low Power consumption, two necessary requirements for in-vehicle deployment. Our highly scalable lineup allows flexibility to the customer to develop platform solutions with re-usable design and SW leading to lowered development costs and fast time to market.

To take all the HW benefits and to consider the HW constraint like Power, deterministic real-time SW, Renesas has developed an open and Integrated development environment based on enabling fast time-to-market for Computer Vision and Deep learning solutions. Easy to use debugging and tuning tools for heterogeneous multi-core hardware will enable efficient SW development while a comprehensive set of example applications and online help supporting self-education will enable a quick ramp-up to beginner.

Qualified compilers and code generators for compliance with functional safety and cyber security requirements ensure Safe and secure SW development.
The integrated cockpit will evolve into a connected HMI by introducing new services through cloud connectivity in addition to the conventional cockpit. Renesas offers optimized, highly integrated cockpit solutions with safety, software portability, and performance scalability as key differentiators.

**R-Car Gen3e**

The R-Car Gen3e offers a scalable line-up for entry to mid-range automotive applications that require high-quality graphics rendering, such as integrated cockpit domain controllers, in-vehicle infotainment (IVI), digital instrument cluster, driver monitoring systems, and LED matrix light.

**R-Car Cockpit Trend**

<table>
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<tr>
<th>2019</th>
<th>2023</th>
<th>2027</th>
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<tr>
<td>Mid-High cockpit HMI user experience</td>
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<tr>
<td>R-Car M3e-2G/H3e-2G</td>
<td>R-Car Next</td>
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<tr>
<td>Entry-Mid cockpit Cost saving &amp; Easy maintenance</td>
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<tr>
<td>R-Car E3e/M3Ne/M3e</td>
<td>R-Car Next</td>
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Digital transformation is accelerating. After changing from the “hardware fixed” world, incorporation of CI/CD on the premise of software download and agile development methods for automotive are required. Arbitration work with cloud computing is the key to design a in-vehicle computing architecture. In addition to conventional in-vehicle technology, the implementation of cloud technology into the vehicle and software DevOps becomes extremely important in automotive world as well as mobile phones.

**Renesas Connected Car Platform**

Renesas offers a cloud-native execution environment that utilizes virtualization technology to realize aka “Kubernetes for vehicles”, which includes the cloud-sync framework such as microservice deployment and container orchestration. It enables your engineers to focus on application development and system designing, even without embedded technology skills.
MEGATREND ARCHITECTURE TRANSFORMATION
CONNECTED GATEWAY / CAR SERVER

Introduction

With its rich product portfolio, Renesas supports automakers’ vision of driving toward the mobility society of the future. The challenges this vision creates are the exponential growth in data bandwidth together with the required service-oriented architecture (SOA). On top of that, advanced functional safety and security features are needed to enable secure data connection between the connected car and cloud services. This mega trend we address with our digital and analog chipset dedicated for Connected Gateway/Car Server applications - a smart chipset solution reducing ECU size and BOM cost.

Key Features R-Car S4 + PMIC + AutoClock™ Timing IC

The Renesas R-Car S4 SoC includes multiple ARM® Cortex® A55, Cortex R52 and is the first SoC offering a full RH850 MCU with multiple cores to control the domain and zone segment. R-Car S4 SoCs support a huge number of automotive interfaces such as 16x CAN FD, 16x LIN, 8x SENT, 1x FlexRay, 4x PCIe V4.0 and an integrated high-bandwidth 3 x 2.5Gbit Ethernet Switch TSN to enable rich communication and connectivity options both inside and outside of the vehicle. Multiple hardware security modules (HSM) provide enhanced security protection against cyber attacks. The entire chipset is being developed in compliance to ISO-26262 to be capable of supporting system safety requirements up to ASIL D.

Benefits

Renesas offer a complete and scalable chipset solution including a tailored PMIC and the new AutoClock™ timing IC and allows an optimized ratio of computing performance versus low power consumption.

By adopting this next generation R-Car S4 customers are able to re-use up to 80% of software code developed for 3rd generation (Gen3) R-Car SoCs and RH850 MCU applications – a clear benefit because it reduces overall project development time/ cost/ risk and allows a better time-to-market. The software package supports real-time cores with various drivers and basic software such as Linux BSP and hypervisors. In addition, a virtual platform (VPF) is available from a partner company, enabling early software development and evaluation.

Samples and evaluation boards are now available for selected customers.
Car body and convenience applications are ever evolving to increase the comfort of both drivers and passengers. Car maker need scalable solutions to have the flexibility to cover a wide range of car models and a broad range of options.

E/E Architecture Evolution and RENESAS Coverage with RL78 and RH850

The updated E/E architecture of today’s cars require semiconductor devices to cover

- Improved Cybersecurity
- Enhanced Functional Safety
- Handle increasing amounts of data
- Energy efficient operation modes
- Over the air SW updates

as the main trends.

Renesas provides cost effective solutions for those challenges by offering scalable roadmaps. Product range starts at Actuator MCU with low pin count (20pin) and extreme low power operation to super high end Zone/Domain controller with 4 times 400MHz CPU operation in a 516BGA package.

Because of that you can find our MCU’s in nearly all body applications like
Zone/Domain ECU, BCM, Lighting, Car access, Wiper, HVAC, Seat, Door, Roof Modules to name only a few.

**Benefit of RENESAS RL78 MCU**
- Scalable line-up from 20pin to 144pin QFP and 16KB to 512KB Flash Memory
- Best-in-class power consumption, and high compute performance, are both possible at low frequency
- High Temperature support $T_a=150^\circ C$
- Hard-&Software Compatibly within the line-up
- Built-in optimal high-precision / speed on-chip oscillator, power-on reset, etc.

**Benefit of RENESAS RH850 MCU**
- Scalable Line-ups from 48pin QFP to 516pin BGA and 1MB to 16MB FLASH memory
- Performance up to 7000 DMIPS real-time performance
- ASIL B/D Support
- Hard-&Software Compatibly across the line-ups
- Evita Full/Medium/Light Security Standard
- Expanded Network I/F: Gbit ETH, 16xCAN-FD,…
- Hypervisor Support
- Full OTA Swap A/B
For chassis systems, the volume of information from sensors is increasing due to the need to coordinate with advanced driver assistance systems (ADAS). Thus, high-speed communication functions as well as high information processing capabilities are needed.

**Electric Power Steering**

As part of efforts to make their vehicles more environmentally friendly, carmakers have increasingly been switching from hydraulic steering assist systems to electric power steering (EPS) using electric motors in order to reduce weight and boost fuel efficiency. In recent years, there has been a trend toward linking functions that assist the driver in operating the vehicle to the EPS system, for example by providing continuously variable steering gear ratio adjustment according to the running speed and steering angle, in addition to simple power steering functionality.

**Brake System**

There are many types of brake systems, including ABS*, antiskid functions for maintaining vehicle stability, regenerative braking and brake control systems for hybrid and electric vehicles, and central vehicle control systems supporting interoperation with other systems such as the engine. As a result, there is demand for MCUs with a variety of functions and performance levels. As with steering systems, the very highest level of functional safety is essential.

*ABS: Anti-lock Brake System

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**Benefits for chassis & safety application in Renesas Electronics**

- Dedicated motor control timer units
- High-performance CPU core with lock step
- High-precision A/D converters
- Interfaces for communicating with other control units.
- Variable safety mechanism for supporting ASIL D*

*ASIL: Automotive Safety Integrity Level. ASIL D is the highest Automotive Safety Integrity Level.
The powertrain segment remains focused on further reduction of emissions and fuel consumption through optimization of traditional ICE engine control concepts.

Domain Controller is becoming a common approach to manage the overall driving strategy between ICE and Electric drive as well as the charging of the car. Renesas’ comprehensive product portfolio is committed to automotive quality and ready to cover a wide range of applications, including Diesel- or Gasoline direct /MPI injection, transmission control, powertrain DCU or powertrain Integration concepts:

- **RH850 MCU family** with dedicated products for ICE, including IP’s for combustion engine control like GTM, MSC and DS-ADC to reduce the CPU load significantly.
- A full line-up for **analog powertrain components** including gate driver, bridge driver, solenoid as well as tailor-sized power management ICs and discrete MOSFET components.
- Broad product portfolio for **sensor ICs** for manifold air pressure, High temperature sensing, differential pressure (particle filters), air mass flow, position and angle sensing.

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**Part List/BOM**

**RH850**
- 32bit Microcontroller → RH850 E2x Series
  - Multi-core, ~400MHz
  - Integrated IPs for engine control Quality → AECQ100
  - Safety → ASIL D
  - Security → EVITA Medium

**Sensor Signal Conditioners → SSC family**
- ZSSC31xx & ZSSC41xx
- LIN, PWM, SENT, analog & switch out
- Up to ASIL C support.

**Power Supply PMIC → RAA27xx family**
- Fault diagnosis, ASIL

**Inductive Position Sensors → IPS2550**
- Smart Actuators → RAA family
  - Integrated H-Bridge for Throttle, ETC
  - Solenoid & BLDC driver
  - Gate pre-driver

**Intelligent Power Devices → RAJ28000x**
- Single Channel High Side Switch
- Full Diagnosis & Protection

**Power Stage → ANL, ANM series**
- 12v and 48v PDMS
- Discrete MOSFETs
The electrification of the powertrain is mandatory to comply with emission regulation. In addition to mild and full hybrids vehicles, the share of pure electric cars is increasing. Renesas’ robust, reliable and safe powertrain solutions help to manage efficient use of energy for the applications mentioned above.

Renesas offers many xEV inverter reference solutions:

- Practical inverter specification for xEV 100kW class motor
- Reference solution kit including Inverter reference design, software, model based design and calibration tool
- Function and performance verified on Renesas dynometer test bench
- 3.9L compact volume by highly integrated products and temperature management
- Superior power efficiency, Achieved 99% maximum inverter efficiency
- Function proven in real car demo

**BOM List for Reference Design**

- RH850/C1M-A2 32bit Microcontroller embedded
- RAA270000 Resolver I/F and Motor Control IP
- R2A25110 Gate driver IC
- RJQ7031/RJU7032 IGBT and FRD
- RV1S2752Q Photo coupler

**Block Diagram and Reference Board**

- External I/F
- Photo coupler
- Microcontroller RH850/C1M-A2
- Resolver I/F
- Gate driver IC
- Digital
- Analog Power
- Inductive Position Sensor
COMPREHENSIVE SOLUTIONS FOR AUTOMOTIVE PRODUCT PORTFOLIO

Microcontroller
- 16-/32-bit MCUs (RL78 & RH850)
- Functional Safety
- Security
- AUTOSAR

System-on-Chip Solutions
- R-Car 64-bit SoC Family
- Software Support
- R-Car Consortium

Analog & Power Products
- Bluetooth Low Energy (BLE)
- Haptics Driver
- LED Driver
- Clocks and Timing Solutions
- Sensor Solutions
- Power Management IC (PMIC)
- Battery Management IC (BMIC)
- Video Signal Processing (VSP)
- Wireless Charging IC
- Automotive HD Link (AHL)
- Gate Driver Unit (GDU)
- PowerMOSFETs
- IGBT
- Intelligent Power Devices (IPD)
In response to user requirements that are rapidly expanding in scope, Renesas offers microcontroller products that provide excellent expandability while allowing customers to make full use of existing resources.

Available in a wide array of memory and package options, Renesas MCUs are fast, highly reliable, low in cost and deliver eco-friendly performance. Incorporating the latest process technology, which enables integration of large-capacity flash memory, Renesas MCUs are used in a wide array of applications – meeting the high quality and high reliability standards of the automotive industry.

### FACILITATING FLEXIBILITY

**MICROCONTROLLER**

- All range application covered at Automotive
- Multi-core technology
- Scalability of hardware and software
- High performance and low power consumption
- Embedded security features
- Guaranteed high-temperature operation
- AUTOSAR support
- Functional safety support

### 32-bit high-performance MCUs

- RH850

### 16-bit ultra-low power MCUs

- RL78

- All Actuator/Sensor application covered at Automotive
- Wide package and memory scalability
- Industry’s lowest level of consumption current
- Guaranteed high-temperature operation
- Hardware safety features
- Built-in a variety of functions for system cost and size reduction
Together with our customers around the world, and as the holder of a premiere global share in the automotive semiconductor business, Renesas has been investigating state-of-the-art functional safety technologies. We have been participating in ISO Working Group for ISO 26262 and other standardization activities to lead the development of functional safety technologies globally. Leveraging our core competencies of the vast experience gained through these activities and our proven track record recognized by our many customers, we propose new system solutions that are optimized to our customers' systems and that can easily satisfy functional safety requirements.

ISO 26262 is the functional safety related standard of electrical and/or electronic system within automotive industry. Although not legally binding, Renesas is fully committed to comply with this standard, developing MCUs, SoCs, analog and power products used in safety-critical applications according to ISO 26262, thus achieving the required automotive safety integrity level: ASIL A to D.

Renesas functional safety products are well recognized by industry leading customers and partners providing well-thought-out and reliable Safety Element out of Context (SEooC) solutions satisfying a very broad range of applications like safety relevant Motor Control or advanced Automated Driving applications.


Customer centricity and time to market are the key success factors for Renesas, to make it easier for you to implement functional safety solutions, Renesas offers the Functional Safety Support Program for Automotive for MCUs and SoCs. It includes, in addition to ISO 26262 work products, a sophisticated FMEDA (Failure Modes, Effects and Diagnostic Analysis) tool named CAR (Customizable Analysis Report, https://www.renesas.com/products/automotive-products/car-tool), technical support for functional safety work products, those explanation sessions and versatile software solutions like software test libraries which are developed according to ISO 26262.

The automotive industry is transforming due to the Connected, Automated, Shared & Services, and Electrified (CASE) megatrends; recent years the importance of vehicle security has taken on a new meaning. Renesas is utilizing our expertise in advanced functional safety in building a robust security culture through industry participation and cybersecurity technology development. Renesas is a contributing member to several national and international security standards such as ISO/SAE 21434, and SAEJ3101. Renesas uses these as a foundation for the Renesas Security Design Lifecycle (SDL) to promote best practices throughout the product lifecycle. Concerning specific technology, Renesas device has an important role as the provider of the Root of Trust within an ECU. Through our innovative portfolio of Hardware Security Modules (HSM), cryptographic accelerators, and security software, Renesas offers security solutions to meet customer requirements across product domains. Furthermore, Renesas strives to meet the State of the Art for advanced cybersecurity features such as cryptographic algorithms, logical/physical attacks mitigation and data latencies concerns; we are constantly monitoring the market to make sure our IP will meet or exceed the current industry demand while anticipating future cybersecurity needs through a holistic approach to our next generation SoCs and MCUs.
Renesas’ system-on-chip (SoC) family, R-Car, is designed for advanced driver assistance systems (ADAS), autonomous drive (AD), car information systems, and connected gateways. Renesas offers end-to-end total solutions from cloud services to sensing and vehicle control that contribute to an autonomous driving society.

- **R-Car in The Future Car Architecture**

- **COMPUTING POWER MEETS VISION PERFORMANCE**

- **R-CAR SYSTEM-ON-CHIP SOLUTIONS**

- **R-Car Key Features**
  - Scalable line-up from Gen3 to Gen4
  - Common HW architecture on major in-vehicle functions
  - Functional Safety support (ISO26262)
  - Integration of in-vehicle peripheral functions (e.g. CAN-FD, FlexRay) and real-time core
  - Advanced function support with dedicated HW engine and scalable performance

- **Benefits**
  - Enable high coverage of ADAS/AD, GW, Cockpit/IVI, and Cluster applications
  - High re-usability of customer assets within R-Car line-up and between generations
  - Contribution to ASIL B–D support of customer systems
  - Contribution to BOM cost reduction
  - Combination of CNN and image recognition engines realizes advanced computer vision processing
The R-Car Consortium brings together system integrators, middleware/application developers, and operating system and tools vendors who are developing solutions for the Connected Car & ADAS market. With highly reliable and technically advanced SoCs from Renesas, and end-to-end development support, customers can get optimal solutions for their requirements. Members of the Consortium receive evaluation boards and software to help co-develop advanced Connected Car & ADAS solutions.

R-Car Consortium: https://www.renesaspartners.com/
Renesas launched online Market Place, which offers a one-stop source of solutions that help accelerate technical innovation for the future mobility market. Developers can download various solutions designed for Renesas’ R-Car automotive system-on-chips (SoCs) directly from the Market Place. Developers can also use the Market Place as a portal to obtain reference evaluation software from R-Car Consortium Proactive Partners or contact Proactive Partner companies directly, allowing for timely support to match customer requirements. Through the Market Place, developers can quickly and easily access R-Car evaluation software, documentation such as hardware manuals, technical updates, application notes, and basic software such as Linux and Android board support packages (BSPs).

**Online Market Place for R-Car**

Renesas Shifts Mobility System Development Into High Gear With Its Online Market Place for R-Car SoC

**Proactive Partners**

Proactive Partners 2021

R-Car Solution Matching System
AUTOSAR is a worldwide development partnership of car manufacturers, suppliers and other companies from the electronics, semiconductor and software industry targeting software architecture standardization of Electronic Control Units (ECUs).

Renesas, registered as Premium member of the AUTOSAR partnership, is deeply involved in standardization activities resulting in developing and releasing of MCAL (Microcontroller Abstraction Layer) software optimized for their RH850 and R-Car product series.

AUTOSAR BSW packages for Renesas MCU’s and SoC’s are available by major 3rd party cooperation partner.
By joining forces, Renesas, Intersil, IDT and Dialog, have created the leading embedded solutions and analog mixed-signal products company, uniquely positioned to help customers succeed in developing innovative applications in the automotive segment.
Our combined portfolio will contribute to accelerating your development and enabling differentiation, while bringing predictability to your application.

### Analog & Power Product Line Up

Rich analog and power products to cover growing application fields

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<th>ADAS</th>
<th>Cockpit</th>
<th>E/E Architecture</th>
<th>Powertrain</th>
<th>xEV</th>
<th>Chassis &amp; Body</th>
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<td>Power Management IC (PMIC)</td>
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<td>Configurable Mixed-Signal IC (CMIC)</td>
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<td>Haptics driver</td>
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<td>Video Signal Processor</td>
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<td>Analog HD Link</td>
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<td>Timing IC</td>
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<td>Wireless Charging</td>
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<td>RADAR</td>
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NEW CAPABILITIES BY JOINING FORCES

ANALOG & POWER PRODUCTS
NEW CAPABILITIES BY JOINING FORCES
ANALOG & POWER PRODUCTS

Clocks and Timing Solutions

Renesas offers the broadest and deepest silicon timing portfolio in the industry. In addition to our wide selection of buffers and clock synthesizer products, we deliver leading-edge system timing solutions to resolve timing challenges in virtually any application.

- **Features**
  - Lowest phase noise and highest performance <500fs and PCIe Gen5 clock on 5P49V60A
  - Industrie’s broadest and deepest portfolio
  - Proven expertise in both analog and digital timing
  - Advanced timing technology
  - Offer flexibility for diversified timing Requirement (Any frequency support on 5P49V60A)

- **Benefits**
  - Extensive online tools library
  - Deep knowledge base / FAQ
  - Complimentary clock tree design and review services
  - Expert engineering support

Sensor Solutions

With more than 20 years of industry experience, Renesas is an expert in providing sensor technologies that enable our customers to design and build best-in-class sensor solutions. As we expand the breadth of our sensor technologies, Renesas will create unique and differentiated sensor solutions.

**Automotive Solutions with "Single-pass" Calibration**

Renesas’ automotive sensor signal conditioning ICs are all-in-one, energy efficient products that are easy-to-use. Our single-pass operation calibration lowers costs by reducing test time without compromising precision, enabling design of cost-effective, accurate sensing systems. These SSCs also offer best-in-class performance with highly integrated operations and support for ISO26262, Automotive EMC, and reliability.

Inductive Position Sensor

Inductive Position Sensor is a product, which has a broad customer base with various applications. This system does not use a magnet. Inductive sensor is robust against environmental contaminants and provides excellent stray field immunity.

- **Features**
  - Contactless position sensor with Sin/cos output differential output signals
  - Automotive qualified AECQ100 grade 0 with temperature range from -40°C up to +160°C
  - ISO26262 supports up to ASIL C requirements
  - Maximum rotational speed up to 600,000 rpm
  - Totally stray field immune

- **Benefits**
  - Superior accuracy and resolution by thinner, lighter and much more cost effective than resolvers
  - Allows through- and side-shaft sensor design
  - Superior accuracy by matching the sensor sectors to the number of pole pair of the motor

Application Examples

- Electric Power Steering (EPS) - BLDC
- Traction Motors
- xSG - Belt or Integrated Starter Generator
- Electric Park Brake
- Oil Pump Motors
NEW CAPABILITIES BY JOINING FORCES

ANALOG & POWER PRODUCTS

**Power Management IC**

Renesas power management IC's are designed as the complimentary power solutions for Renesas MCU's and SoC’s. Their optimized performance helps to reduce system BOM cost, PCB area and system design development time.

- **Features**
  - Ideal power solution for Renesas MCU and SoC (e.g. RH850/E1x/C1x/P1x, R-Car Gen3, Gen4)
  - Integrated fault diagnosis and monitor functions for ASIL applications

- **Benefits**
  - Optimized specifications help reduce system BOM cost and PCB area
  - Closely aligned MCU/SoC and PMIC Solutions offer optimized development times

**Battery Management IC**

Battery management IC’s have the best voltage measurement accuracy (Initial accuracy <±2.0mV) and Long-Term Drift (<±6mV@6σ after 15 years on board). ASIL D Battery Management System (BMS) Design Solution available in combination with RH850/P1M.

- **Features**
  - Class leading on-board accuracy *±2.5mV ±3σ post solder
  - ±5V cell input measurement range *For Fuel Cells & Bus Bars
  - Low power, high security Daisy Chain *Capacitor or Transformer coupling
  - System level S/W Drivers/Support *ASIL D Complex Device Drivers

- **Benefits**
  - BMS Reference Design with ISL78714 (BMIC) & RH850/P1M (MCU)
  - *Available Complex S/W Drivers
  - Best Long-Term Drift measurement accuracy
  - Balance All Cells Simultaneously

**Video Signal Processing (VSP)**

Renesas VSP products include basic Analog Video Decoders and Advanced LCD Controllers. Optimized for Automotive video & display applications, providing best-in-class video quality, system robustness & flexibility.

- **Features**
  - 1 & 4 Channel Analog Video Decoders
    * Supports BT.656 or MIPI-CSI2 output
    * Built-in diagnostics (short detection)
  - Highly Integrated LCD Controllers
    * Supports Digital & Analog inputs up to 1080p/60
    * Integrated Image Diagnostics with Frozen & Corrupt Image Detection
    * Drives most automotive LCD panels
    * H/W based Fast Boot (<500ms)

- **Benefits**
  - Video Decoders provide superior video quality with low power consumption
  - LCD Controllers add versatility and reliability to Automotive Display Systems
    * Arbitrary horizontal & vertical video scaling for any resolution up to Full HD 1080p
    * Flexible I/O’s: MIPI-CSI2, LVDS, TTL, Analog

- **VSP Product Categories**

  Video Decoders
  - TW99xx, ISL799xx, RAA2799xx

  LCD Display Controllers
  - TW88xx, RAA2788xx
NEW CAPABILITIES BY JOINING FORCES

ANALOG & POWER PRODUCTS

Wireless Charging IC
Qi compatible wireless charging ICs for Automotive deliver charging speeds that rival traditional plug-in charging

- Industry first, flexible ARM® Cortex®-M0-based SoC architecture
- Industry-leading efficiency
  - >75% end-to-end
  - As fast as wired
  - Cool operation temperature
- Very low EMI
- Unique and proven hardware / algorithm implementation

- Significant reduction of charging time by up to 20W wireless solutions
- Design support:
  - reference design kits enable fast prototyping and time to market
  - Extensive documentation library

Automotive HD Link (AHL)
Automotive High-Definition Link (AHL) is a new video transmission technology designed to reduce the cost of transporting high resolution video from the camera to the ECU. Optimized for parking assistance applications.

- HD Video Transmission Link
  *RAA279971 AHL video encoder
  *RAA279972 AHL 1ch video decoder
- No Latency
- Independent Control Channel
  - *Works without active video
- Robust against interference
- Supports non-standard resolutions
- Up to 30m transmission distance

- Reduce HD camera system costs by utilizing lower cost cables (UTP) and connectors.
- Re-use existing NTSC camera cable infrastructure with HD camera resolutions
- Initialize camera from the ECU with built-in bi-directional control channel (I2C)

Gate Driver Unit (GDU)
Renesas GDU is a product designed for xEV inverter. The performance has been proven by Renesas reference board and it contributes the reduction of BOM cost and engineering development workload.

- Low Ron (1 ohm max.), IGBT gate driver with 2.5k Vrms isolation
- Support IGBT parallel connection
- Built-in analog I/F can help to monitor the operation condition of secondary side (IGBT side)

- Provides cost-effective solution (20% BOM Cost reduction expected)
- Contributes to reduced engineering development workload

Solution Example
Inverter reference design with GDU

- Provides cost-effective solution (20% BOM Cost reduction expected)
- Contributes to reduced engineering development workload

*In case of 3 phase
NEW CAPABILITIES BY JOINING FORCES
ANALOG & POWER PRODUCTS

AUTOMOTIVE SENSOR SIGNAL CONDITIONER (SSC)
Renesas’ best-in-class automotive sensor signal conditioning (SSC) ICs are optimized to withstand harsh automotive environments, requiring low supply current to reduce power consumption (critical for PHEV, BEV and FCEV vehicles), offering excellent EMC and ESD protection to ensure safety and reliability.

- Capable of measuring resistive bridge sensor signals
- Temperature measurement using external diode/PTC/TCR or internal (PTAT) sensor
- Ability to cover large sensor span & high accuracy over the entire temp. range (-40°C to 150°C)
- Over-voltage and reverse polarity protection, robust EMC performance, and multiple diagnostic features
- Output signal as ratio-metric analog or digital SENT
- Flexible adoption of the bridge sensor technology, offering offset compensation and high analog gain
- Best-in-class signal processing technology delivering highly accurate and enhanced output signal
- Minimal EOL (end-of-line) production costs during mass production using digital calibration
- Minimum amount of external components to design of sensor modules with best-in-class form factor

GreenPAK™ CONFIGURABLE MIXED-SIGNAL ICs (CMICs)
Configurable solutions enable flexible electronic designs while reducing BoM count, cost, and sourcing issues.

- Cost effective NVM programmable IC containing digital and analog resources which can be implemented into 100s of different functions
- With GreenPAK designer software/development kit, quickly respond to changing design requirements and increase productivity at the design and prototype verification stages
- Reduce solution size, cost & power consumption
- Dramatically reduce reliability issues
- Configurability allows fast cost-effective differentiation

BLUETOOTH LE (BLE)
Ultra low power, ultra compact Bluetooth LE IC for wireless sensor applications

- Lowest power consumption
- 2-way communication
- Removes need for dedicated control unit
- Low-cost manufacturing on 2L PCB
- Minimum BOM
- Space optimized PCB trace antenna reference designs available

Application Example
### Haptics Driver

Low-power, wide-bandwidth haptic driver for vibrations and clicks using ERM (eccentric rotating mass motor) and LRA (linear resonant actuator) applications

<table>
<thead>
<tr>
<th>Features</th>
<th>Benefits</th>
</tr>
</thead>
<tbody>
<tr>
<td>• Dynamic display control panels in the cabin that utilize haptics to provide immediate feedback to the driver – gives tactile feedback</td>
<td>• 80% lower idle current than the competition</td>
</tr>
<tr>
<td>• Provides multiple feedback states – not just a simple click</td>
<td>• AEC-Q100 Grade 2, 3x3mm WFQFN package</td>
</tr>
<tr>
<td>• Applications : Button replacement, Rotary Encoding, Steering wheel fingertip feedback, etc</td>
<td></td>
</tr>
</tbody>
</table>

### LED Backlight Driver

Advanced technology solutions enable local dimming, high-contrast, high-quality, large displays

<table>
<thead>
<tr>
<th>Features</th>
<th>Benefits</th>
</tr>
</thead>
<tbody>
<tr>
<td>• 32 channels</td>
<td>• Patented BroadLED™ adaptive switch technology</td>
</tr>
<tr>
<td>• Integrated current sink MOSFETs</td>
<td>• Reduces power dissipation in the driver</td>
</tr>
<tr>
<td>• External current sense resistors for flexibility and accuracy in broad range of LED applications</td>
<td>• Maintains operation during LED short with minimal temperature increase</td>
</tr>
<tr>
<td>• Comprehensive protection features</td>
<td>• Enables use of less costly, loosely binned LED arrays for lower BOM cost</td>
</tr>
<tr>
<td></td>
<td>• AnyMode™ technology reduces video motion blur</td>
</tr>
<tr>
<td></td>
<td>• 13-bit PWM dimming and 11-bit analog dimming improve dynamic range</td>
</tr>
</tbody>
</table>
NEW CAPABILITIES BY JOINING FORCES
ANALOG & POWER PRODUCTS

Renesas offers an extensive lineup of power MOSFET products covering a wide range of voltage and current ratings as well as different package types to enable customers building various types of electric equipment to select the optimal device for their specific application. We also supply bare-die IGBT products that enable customers to achieve an ideal match with the modules they design as well as IPDs (intelligent power devices).

**Power MOSFETs**

Focusing performance driven application to contribute to system innovation. (high efficiency, down-sizing, robust design)

<table>
<thead>
<tr>
<th>Features</th>
<th>Benefits</th>
<th>Low Ron package</th>
<th>Tape &amp; Reel</th>
</tr>
</thead>
<tbody>
<tr>
<td>WW Top class Low Ron with Super junction structure</td>
<td>High efficiency based on excellent Ron and switching performance</td>
<td>TO-263-7</td>
<td>for Bare Die</td>
</tr>
<tr>
<td>Extensive lineup for 12V / 48V battery application</td>
<td>Down-sizing by selecting optimized package from product line-up and bare die support options</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Excellent quality</td>
<td>Robust design with high withstanding capability and sensing option</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Customized Bare Die support for pad layout &amp; shipment form</td>
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</tbody>
</table>

**IGBT**

Renesas supplies bare-die IGBT products that enable customers to achieve an ideal matching with the system and modules they design.

<table>
<thead>
<tr>
<th>Features</th>
<th>Benefits</th>
<th>Thin Wafer Technology</th>
</tr>
</thead>
<tbody>
<tr>
<td>High performance &amp; high quality IGBT bare die for HEV/PHV/EV</td>
<td>High efficiency and low heat generation based on low power consumption</td>
<td>IGBT</td>
</tr>
<tr>
<td>WW Top level performance achieved with low Vce (sat) and faster switching</td>
<td>Enable to adopt various mounting method with top metal options</td>
<td>FRD</td>
</tr>
<tr>
<td>Voltage rating variations from 650V to 1200V</td>
<td>High quality based on various testing options and qualification test</td>
<td>IGBT &amp; FRD Pair products</td>
</tr>
<tr>
<td>Current and Temp sensing (optional)</td>
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**Intelligent Power Device (IPD)**

Replaces mechanical relays for longer lifetime, smaller size, lighter weight, and extended functionality.

<table>
<thead>
<tr>
<th>Features</th>
<th>Benefits</th>
<th>Solution Example</th>
</tr>
</thead>
<tbody>
<tr>
<td>Proven MOSFET and Control-Chip Technology in a single package</td>
<td>Mechanical relay replacement offering better lifetime, size, weight and functionality</td>
<td>IPD</td>
</tr>
<tr>
<td>Low ON-Resistance and wide SOA</td>
<td>Switching of high currents of more than 30A</td>
<td>Load</td>
</tr>
<tr>
<td>Self-protection against short circuit, overcurrent and overtemperature</td>
<td>Easy control by MCU with reduced power consumption</td>
<td>drive</td>
</tr>
<tr>
<td>Self-diagnostic and monitoring functions</td>
<td>Contributing to high system reliability by integrated smart protections</td>
<td>Status of load</td>
</tr>
<tr>
<td>High max operating temperature</td>
<td>Efficient drive of resistive, inductive or capacitive loads</td>
<td>&amp; Diagnosis</td>
</tr>
<tr>
<td>AEC-Q100 qualified and RoHS compliant</td>
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